

# IBIS Chair's Report

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Randy Wolff  
Micron Technology  
Chair, IBIS Open Forum

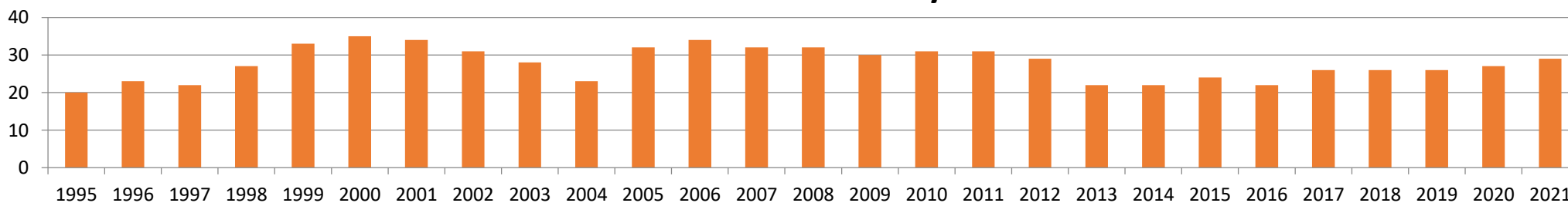
2021 Virtual Asian IBIS Summit – Japan  
November 12, 2021



# 29 IBIS Members (Organization-based)



**Number of Members by Year**



# IBIS Officers June 2021- May 2022

Chair: *Randy Wolff, Micron Technology*

Vice-Chair: *Lance Wang, Zuken USA*

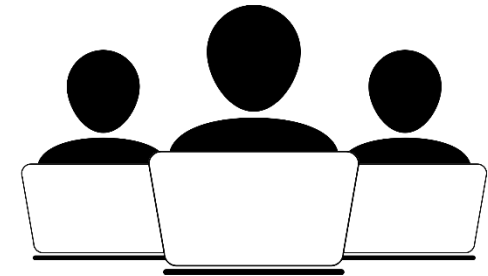
Secretary: *Mike LaBonte, MathWorks (SiSoft )*

Treasurer: *Bob Ross, Teraspeed Labs*

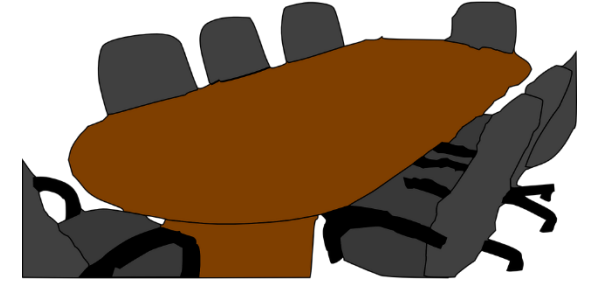
Librarian: *Zhiping Yang, Google (Waymo)*

Postmaster: *Curtis Clark, ANSYS*

Webmaster: *Steve Parker, Marvell*



# IBIS Meetings



- Weekly teleconferences
  - Quality task group (Tuesdays, 09:00 PT)
  - Advanced Technology Modeling (ATM) task group (Tuesdays, 12:00 PT)
  - Interconnect task group (Wednesdays, 08:00 PT)
    - Currently suspended as Editorial task group prepares IBIS 7.1 document
  - Editorial task group (Wednesdays, 08:00 PT)
- IBIS Open Forum teleconference every 3 weeks (Fridays, 08:00 PT)
- IBIS Summit meetings (USA and international)
  - DesignCon, IEEE SPI, IEEE EMC+SIPI, Shanghai, Taipei, Tokyo (JEITA-organized)
- Participants: ~323 in 2020

# SAE ITC

- SAE Industry Technologies Consortia is the parent organization of the IBIS Open Forum
- IBIS is assisted by SAE employees José Godoy, Phyllis Gross, and Laurie Strom
- SAE ITC provides financial, legal, and other services
- <https://www.sae-itc.com/>



# Task Groups



- Advanced Technology Modeling Task Group
  - Chair: Arpad Muranyi, Siemens EDA
  - [https://ibis.org/atm\\_wip/](https://ibis.org/atm_wip/)
  - Develop non-interconnect technical BIRDS
- Editorial Task Group
  - Chair: Michael Mirmak, Intel
  - [https://ibis.org/editorial\\_wip/](https://ibis.org/editorial_wip/)
  - Produce IBIS specification documents
- Interconnect Task Group
  - Chair: Michael Mirmak, Intel
  - [https://ibis.org/interconn\\_wip/](https://ibis.org/interconn_wip/)
  - Develop on-die/package/module/connector interconnect modeling BIRDS
- Quality Task Group
  - Chair: Mike LaBonte, MathWorks (SiSoft)
  - [https://ibis.org/quality\\_wip/](https://ibis.org/quality_wip/)
  - Oversee IBISCHK parser testing and development

BIRD = Buffer Issue Resolution Document

# IBIS Milestones

## I/O Buffer Information Specification

- 1993-1994 **IBIS 1.0-2.1:**
  - Behavioral buffer model (fast simulation)
  - Component pin map (easy EDA import)
- 1997-1999 **IBIS 3.0-3.2:**
  - Package models
  - Electrical Board Description (EBD)
- 2002-2006 **IBIS 4.0-4.2:**
  - Receiver models
  - AMS languages
- 2007-2012 **IBIS 5.0-5.1:**
  - IBIS-AMI SerDes models
  - Power-aware model

## I/O Buffer Information Specification

- 2013-2015 **IBIS 6.0-6.1:**
  - PAM4 multi-level signaling
  - Power delivery package models
- 2019 **IBIS 7.0:**
  - Back-channel time-domain support
  - Interconnect modeling using IBIS-ISS and Touchstone
- 2021 **IBIS 7.1 (in progress)**
  - DDRx IBIS-AMI support
  - Electrical Module Description (EMD)
  - IBIS-AMI back-channel statistical optimization

## Other Work

- 1995: **ANSI/EIA-656 (IBIS 2.1 International standard)**
- 1999: **ANSI/EIA-656-A (IBIS 3.2 International standard)**
- 2001: **IEC 62014-1 (IBIS 3.2 International standard)**
- 2003: **Interconnect Model Specification (ICM 1.0)**
- 2006: **ANSI/EIA-656-B (IBIS 4.2 International standard)**
- 2009: **Touchstone 2.0**
  - Official Touchstone donated from Agilent/Keysight
- 2011: **IBIS-ISS 1.0 (Interconnect SPICE Subcircuit)**
  - Subset of HSPICE
- **IBISCHK:** IBIS file syntax parser
  - Current version 7.0.2
  - Source code available for purchase
  - Compiled executables available free of charge
- **TCHK2:** Touchstone 2.0 file syntax parser
  - Current version 2.0.1
  - Source code available for purchase
  - Compiled executables available free of charge

# Planning for IBIS Version 7.1

Official BIRD content for IBIS 7.1 based on Open Forum vote held July 16, 2021.

BIRD ID	BIRD Title	Approval Date	Notes
195.1	<a href="#">Enabling [Rgnd] and [Rpower] Keywords for Input Models</a>	August 31, 2018	IBIS-AMI
197.7	<a href="#">New AMI Reserved Parameter DC_Offset</a>	February 21, 2020	IBIS-AMI (for DDRx)
198.3	<a href="#">Keyword Additions for On-Die PDN (Power Distribution Network) Modeling</a>	August 7, 2020	Power Integrity
199	<a href="#">Fix Rx Receiver Sensitivity Inconsistencies</a>	June 7, 2019	IBIS-AMI
200	<a href="#">C_comp Model Using IBIS-ISS or Touchstone</a>	September 27, 2019	[Model] C_comp
201.1	<a href="#">Back-channel Statistical Optimization</a>	July 17, 2020	IBIS-AMI
202.3	<a href="#">Electrical Descriptions of Modules</a>	March 12, 2021	EMD (Next Gen EBD)
203	<a href="#">Submodel Clarification</a>	April 24, 2020	Editorial
205	<a href="#">New AMI Reserved Parameter for Sampling Position in AMI_Init Flow</a>	June 26, 2020	IBIS-AMI
206	<a href="#">Clarification of text "transition time"</a>	September 18, 2020	Editorial
207	<a href="#">New AMI Reserved Parameters Component_Name and Signal_Name</a>	October 9, 2020	IBIS-AMI (for DDRx)
208	<a href="#">Clock-Data Pin Relationship Keyword</a>	January 8, 2021	IBIS clock/data relationship
209	<a href="#">Make Clock Times Output Required for Clock Executable Models</a>	March 12, 2021	IBIS-AMI (for DDRx)
212	<a href="#">Clarification of PAM4_UpperThreshold, PAM4_CenterThreshold, PAM4_LowerThreshold</a>	May 14, 2021	Editorial



# Planning for IBIS Version 7.1

Additional BIRDS from Editorial Task Group for inclusion in IBIS 7.1

BIRD ID	BIRD Title	Approval Date	Notes
214	<a href="#">Change "bit time" to "symbol time"</a>	October 8, 2021	Editorial
215	<a href="#">Back-channel Statistical Optimization Editorial Update</a>	TBD	Supersedes BIRD201.1

Other BIRDS

BIRD ID	BIRD Title	Expected Status
166.4	<a href="#">Resolving problems with Redriver Init Flow</a>	To be rejected (in favor of BIRD211.x)
181.1	<a href="#">I-V Table Clarifications</a>	Delayed until future IBIS version
190	<a href="#">Clarification for Redriver Flow</a>	To be rejected (in favor of BIRD211.x)
204	<a href="#">DQ DQS GetWave Flow for Clock Forwarding Modeling</a>	Superseded by BIRD209
210	<a href="#">New Redriver AMI Flow</a>	To be rejected (in favor of BIRD211.x)
211.x	<a href="#">IBIS AMI Reference Flow Improvements</a>	Delayed until future IBIS version
213	<a href="#">Extending IBIS-AMI for PAMn Analysis</a>	Delayed until future IBIS version

# What's Next for IBIS?

- IBIS participants have broad experience in SI and PI with unique perspectives of model creators, EDA tool vendors, system architects, and system-level simulation
- IBIS Open Forum's highly collaborative task groups are up for the challenge of addressing the SI and PI demands of new signaling technologies:
  - Expanded system-level perspective
    - Clock/data relationships, timing information, equalization training
  - PAMn (PAM3 duobinary, PAM5, etc.) including unique challenges of single-ended versions
  - Potential for IBIS to enable improved modeling/analysis of PDN
    - Voltage regulator models
    - Chip power models

# Participation in IBIS

- The success of IBIS depends on active participation and volunteering
- Bringing your ideas and talents to IBIS
  - Task groups for technical discussions and document editing
  - IBIS email reflectors
  - Open Forum teleconferences for event planning and voting
  - Summit presentations
  - IBIS Board and task group volunteering
  - Writing BIRDs – Buffer Issue Resolution Documents
    - Official method for submitting a proposed change to the IBIS specification
    - Many developed collaboratively in task groups
    - Discussed and voted on in Open Forum meetings



# IBIS Website Resources

IBIS Summits

Task Group Info

Spec documents

BIRDs List

Email support

Syntax Parser

Downloads

The screenshot shows the IBIS Open Forum website. On the left is a blue navigation sidebar with the IBIS logo at the top. The main content area has a blue header with the text 'Welcome to the IBIS Open Forum'. Below the header is a yellow 'NEW' banner announcing 'Touchstone Parser TSCHK2.0.1 is now available: TSCHK2 : [TSCHK2](#)'. The main content is divided into two sections: 'Our Specifications' and 'Our Members'. 'Our Specifications' lists: I/O Buffer Information Specification (with links to IBIS 7.0, SAE/EIA-STD-656-B, and IEC-62014-1), IBIS Interconnect Modeling Specification (with links to ICM 1.1 and SAE/GEIA-STD-0001), IBIS Interconnect SPICE Subcircuit Specification (with link to IBIS-ISS 1.0), and Touchstone® File Format Specification (with link to Touchstone 2.0). 'Our Members' displays a grid of logos for various companies including Ansys, Applied Simulation Technology, Broadcom, Cadence, Celestica, Cisco, Dassault Systemes, Ericsson, Google, Huawei, Infineon, Instituto de Telecomunicacoes, Intel, Keysight Technologies, Luminous, Marvell, MathWorks, Maxim Integrated, Micron, Missouri S&T, NXP, SerDes Design.Com, Siemens, ST (life.augmented), Synopsys, Teraspeed Labs, Xilinx, ZTE, and Zuken.

# [Thank You]



IBIS Open Forum:

Web: <https://ibis.org>

Email: [info@ibis.org](mailto:info@ibis.org)

We welcome participation  
by all IBIS model makers,  
EDA tool vendors, IBIS model  
users, and interested parties.